

**AMENDMENTS TO THE SPECIFICATION**

***Please replace the present title with the following rewritten title:***

**APPARATUS FOR EQUIPPING SUBSTRATES WITH HANDLING**  
**ELECTRICAL COMPONENTS**

***Please delete the present abstract of the disclosure in favor of the following replacement Abstract of the Disclosure:***

**ABSTRACT OF THE DISCLOSURE**

An apparatus for placing handling electrical components upon a substrate. The apparatus is provided with a fitting head. The head may include and at least one gripper[,]] and the fitting head has a storage element which can be successively filled with the electrical components. The fitting head first moves may move over the substrate, then and the gripper successively removes may remove components from the storage element and places then place them onto the substrate in a proper location. The apparatus offers shortened movement paths, and fitting performance is increased.